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PMEG45T10EXD

45 V, 1 A Trench MEGA Schottky barrier rectifier

4 January 2022 **Product data sheet**

1. General description

Trench Maximum Efficiency General Application (MEGA) Schottky barrier rectifier encapsulated in a CFP2-HP (SOD323HP) power flat lead Surface-Mounted Device (SMD) plastic package.

2. Features and benefits

- Low forward voltage
- Low Q_{rr} and low I_{RM}
- Low leakage current
- High power capability due to clip-bonding technology
- Power flat lead plastic package with exposed heatsink for optimal thermal connection

3. Applications

- High efficiency DC-to-DC conversion
- Switch mode power supply
- Freewheeling applications
- Reverse polarity protection
- OR-ing

4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
$I_{F(AV)}$	average forward current	δ = 0.5; f = 20 kHz; square wave; T_{sp} ≤ 172 °C		-	-	1	A
V_R	reverse voltage	T_j = 25 °C		-	-	45	V
V_F	forward voltage	I_F = 1 A; pulsed; T_j = 25 °C	[1]	-	450	520	mV
I_R	reverse current	V_R = 45 V; pulsed; T_j = 25 °C	[1]	-	3	20	µA
		V_R = 45 V; pulsed; T_j = 125 °C	[1]	-	2.5	8	mA

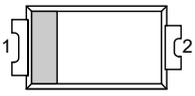
[1] Very short pulse, in order to maintain a stable junction temperature.

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5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	K	cathode	 Transparent top view **CFP2-HP (SOD323HP)**	 *sym001*
2	A	anode		

6. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
PMEG45T10EXD	CFP2-HP	SOD323HP: plastic surface-mounted package with solderable lead ends; 2.2 mm x 1.3 mm x 0.68 mm body	SOD323HP

7. Marking

Table 4. Marking codes

Type number	Marking code
PMEG45T10EXD	2H

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V_R	reverse voltage	T_j = 25 °C		-	45	V
I_F	forward current	δ = 1; T_{sp} ≤ 171 °C		-	1.4	A
$I_{F(AV)}$	average forward current	δ = 0.5; f = 20 kHz; square wave; T_{sp} ≤ 172 °C		-	1	A
I_{FSM}	non-repetitive peak forward current	t_p = 8.3 ms; half sine wave; $T_{j(init)}$ = 25 °C		-	15	A
P_{tot}	total power dissipation	T_{amb} ≤ 25 °C	[1]	-	0.65	W
			[2]	-	1.2	W
T_j	junction temperature			-	175	°C
T_{amb}	ambient temperature			-55	175	°C
T_{stg}	storage temperature			-65	175	°C

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.
[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm^2.

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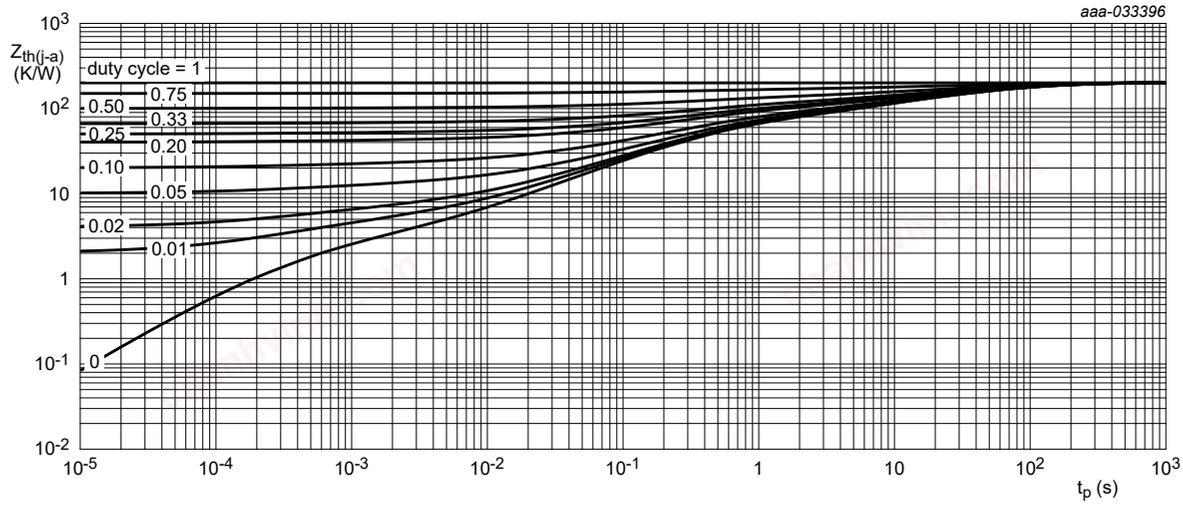
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9. Thermal characteristics

Table 6. Thermal characteristics

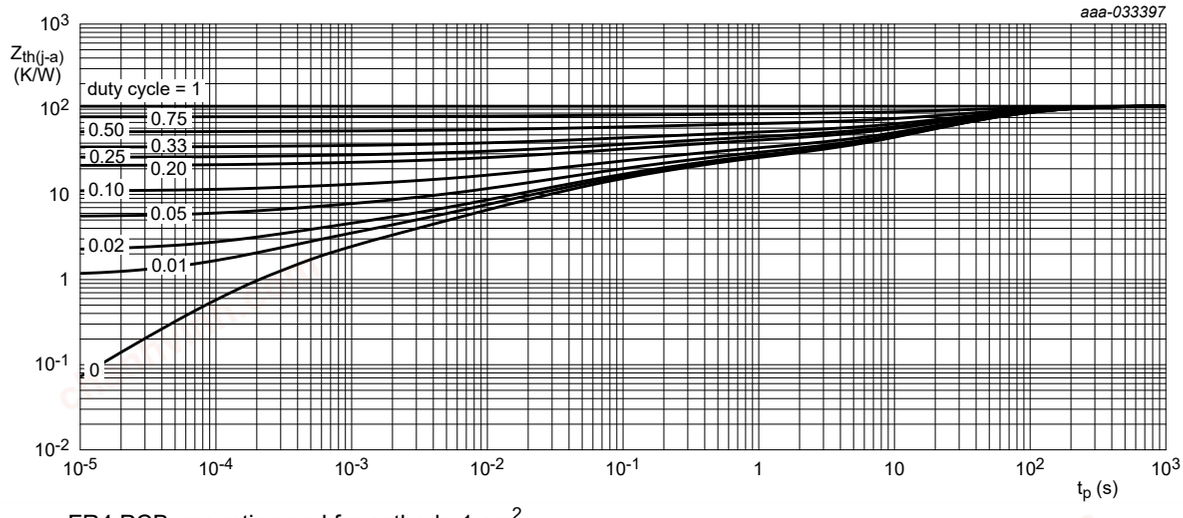
Symbol	Parameter	Conditions		Min	Typ	Max	Unit
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air	[1] [2]	-	-	230	K/W
			[1] [3]	-	-	125	K/W
$R_{th(j-sp)}$	thermal resistance from junction to solder point		[4]	-	-	6	K/W

[1] For Schottky barrier diodes thermal runaway has to be considered, as in some applications the reverse power losses P_R are a significant part of the total power losses.
[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
[3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm^2.
[4] Soldering point of cathode tab.



FR4 PCB, standard footprint

Fig. 1. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values



FR4 PCB, mounting pad for cathode 1 cm^2

Fig. 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

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10. Characteristics

Table 7. Characteristics

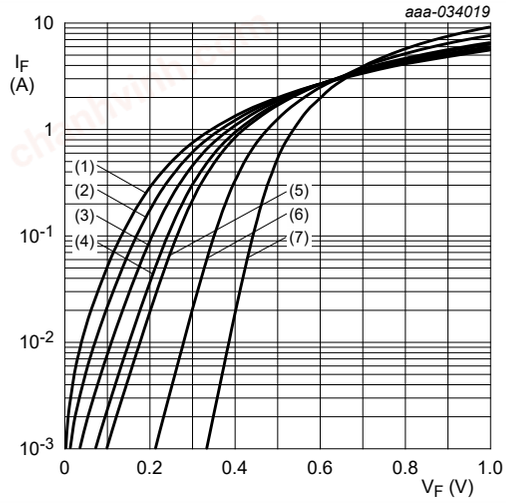
Symbol	Parameter	Conditions		Min	Typ	Max	Unit
$V_{(BR)R}$	reverse breakdown voltage	I_R = 1 mA; pulsed; T_j = 25 °C	[1]	45	-	-	V
V_F	forward voltage	I_F = 0.1 A; pulsed; T_j = 25 °C	[1]	-	330	380	mV
		I_F = 0.5 A; pulsed; T_j = 25 °C	[1]	-	400	450	mV
		I_F = 0.7 A; pulsed; T_j = 25 °C	[1]	-	420	470	mV
		I_F = 1 A; pulsed; T_j = 25 °C	[1]	-	450	520	mV
		I_F = 1 A; pulsed; T_j = -40 °C	[1]	-	505	575	mV
		I_F = 1 A; pulsed; T_j = 125 °C	[1]	-	360	430	mV
		I_F = 1 A; pulsed; T_j = 150 °C	[1]	-	340	410	mV
I_R	reverse current	V_R = 10 V; pulsed; T_j = 25 °C	[1]	-	1.5	8.8	µA
		V_R = 45 V; pulsed; T_j = 25 °C	[1]	-	3	20	µA
		V_R = 45 V; pulsed; T_j = 125 °C	[1]	-	2.5	8	mA
		V_R = 45 V; pulsed; T_j = 150 °C	[1]	-	10	35	mA
C_d	diode capacitance	V_R = 4 V; f = 1 MHz; T_j = 25 °C		-	130	-	pF
		V_R = 10 V; f = 1 MHz; T_j = 25 °C		-	80	-	pF
t_{rr}	reverse recovery time step recovery	I_F = 0.5 A; I_R = 1 A; $I_{R(meas)}$ = 0.25 A; T_j = 25 °C		-	4.5	-	ns
	reverse recovery time ramp recovery	dI_F/dt = 100 A/µs; I_F = 1 A; V_R = 30 V; T_j = 25 °C		-	8	-	ns
I_{RM}	peak reverse recovery current			-	0.36	-	A
Q_{rr}	reverse recovery charge			-	2	-	nC
V_{FRM}	peak forward recovery voltage	I_F = 0.5 A; dI_F/dt = 20 A/µs; T_j = 25 °C		-	405	-	mV

[1] Very short pulse, in order to maintain a stable junction temperature.

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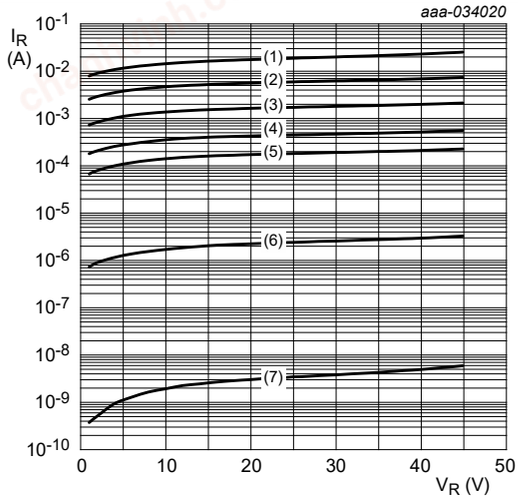
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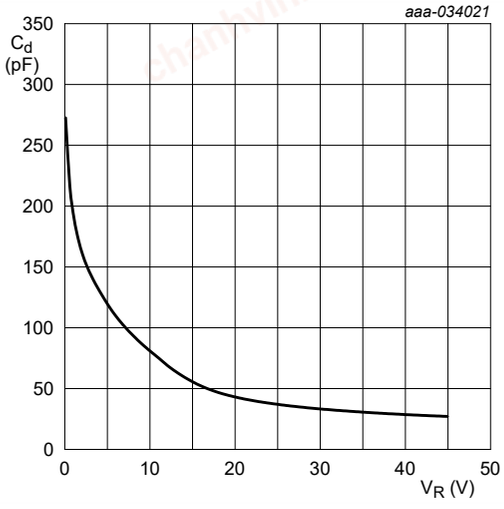
pulsed condition
(1) Tj = 175 °C
(2) Tj = 150 °C
(3) Tj = 125 °C
(4) Tj = 100 °C
(5) Tj = 85 °C
(6) Tj = 25 °C
(7) Tj = -40 °C

Fig. 3. Forward current as a function of forward voltage; typical values



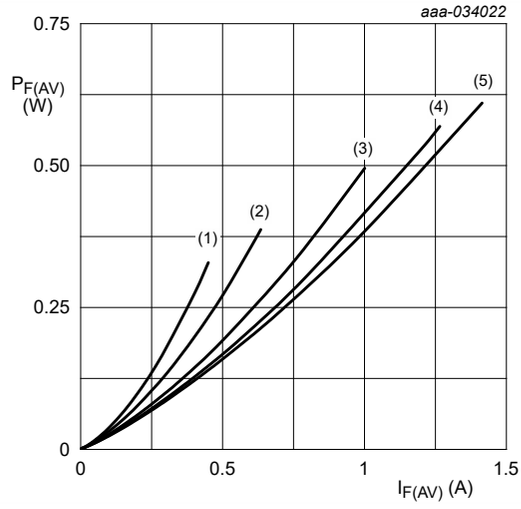
pulsed condition
(1) T_j = 175 °C
(2) T_j = 150 °C
(3) T_j = 125 °C
(4) T_j = 100 °C
(5) T_j = 85 °C
(6) T_j = 25 °C
(7) T_j = -40 °C

Fig. 4. Reverse current as a function of reverse voltage; typical values



f = 1 MHz; T_{amb} = 25 °C

Fig. 5. Diode capacitance as a function of reverse voltage; typical values



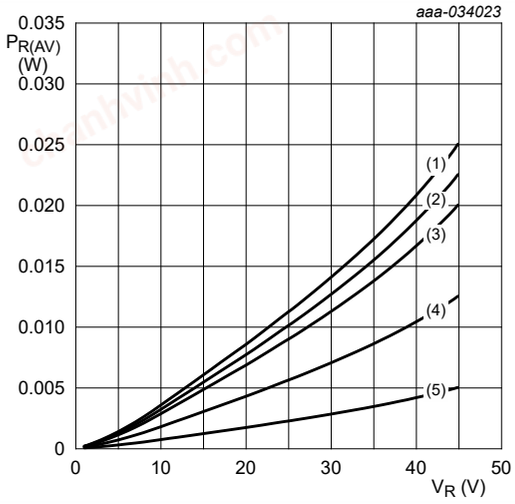
T_j = 100 °C
(1) δ = 0.1
(2) δ = 0.2
(3) δ = 0.5
(4) δ = 0.8
(5) δ = 1; DC

Fig. 6. Average forward power dissipation as a function of average forward current; typical values

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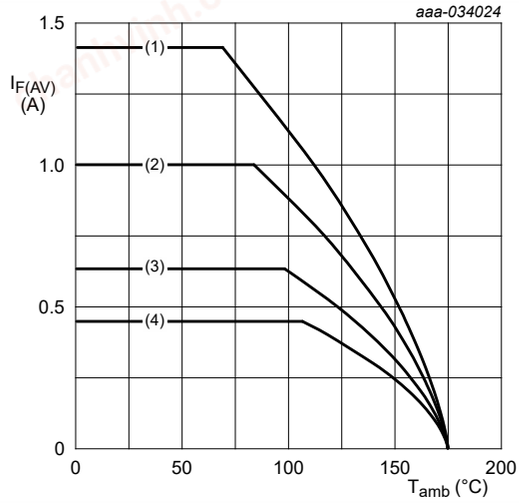
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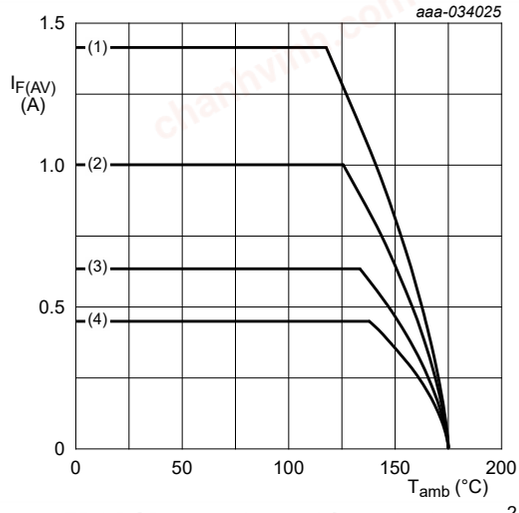
T_j = 100 °C
(1) δ = 1; DC
(2) δ = 0.9
(3) δ = 0.8
(4) δ = 0.5
(5) δ = 0.2

Fig. 7. Average reverse power dissipation as a function of reverse voltage; typical values



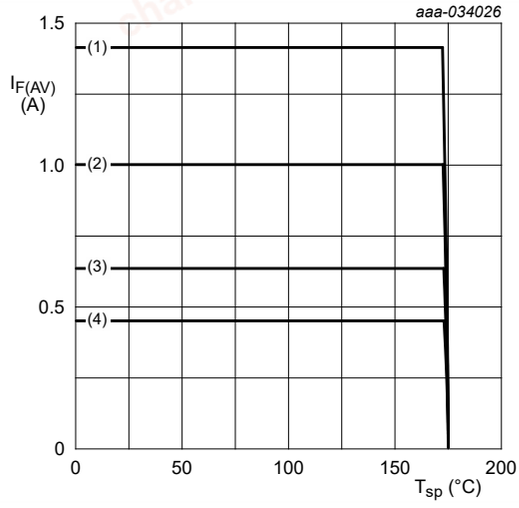
FR4 PCB, standard footprint
T_j = 175 °C
(1) δ = 1; DC
(2) δ = 0.5; f = 20 kHz
(3) δ = 0.2; f = 20 kHz
(4) δ = 0.1; f = 20 kHz

Fig. 8. Average forward current as a function of ambient temperature; typical values



FR4 PCB, mounting pad for cathode 1 cm^2
T_j = 175 °C
(1) δ = 1; DC
(2) δ = 0.5; f = 20 kHz
(3) δ = 0.2; f = 20 kHz
(4) δ = 0.1; f = 20 kHz

Fig. 9. Average forward current as a function of ambient temperature; typical values



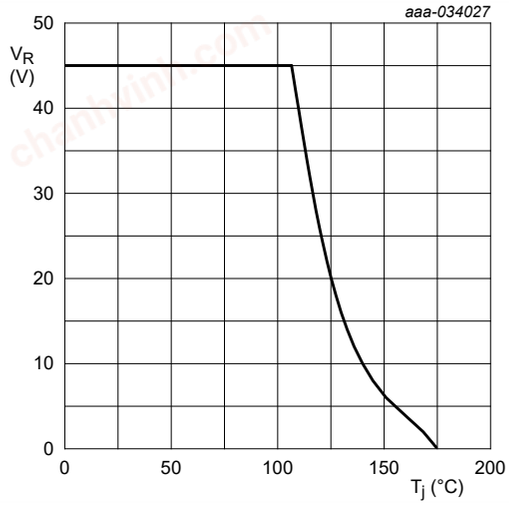
Tj = 175 °C
(1) δ = 1; DC
(2) δ = 0.5; f = 20 kHz
(3) δ = 0.2; f = 20 kHz
(4) δ = 0.1; f = 20 kHz

Fig. 10. Average forward current as a function of solder point temperature; typical values

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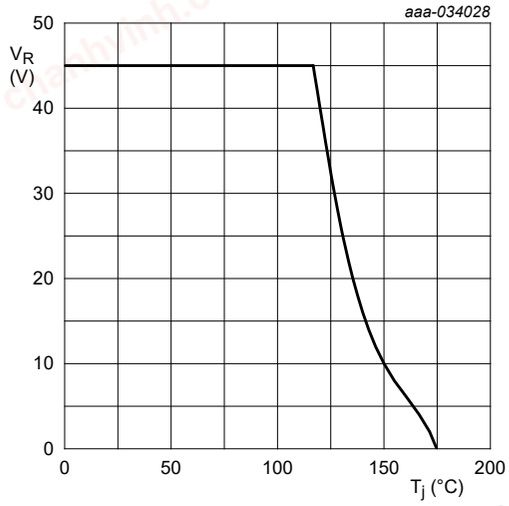
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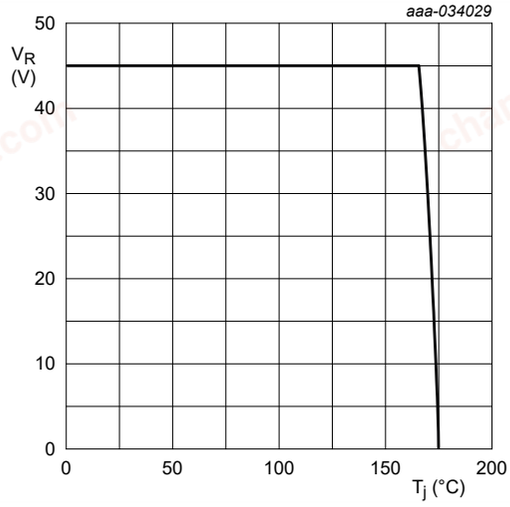
FR4 PCB, standard footprint
R_{th} = 230 K/W

Fig. 11. Derated maximum reverse voltage as a function of junction temperature; typical values



FR4 PCB, mounting pad for cathode 1 cm^2
R_{th} = 125 K/W

Fig. 12. Derated maximum reverse voltage as a function of junction temperature; typical values



Soldering point of cathode tab
R_{th} = 6 K/W

Fig. 13. Derated maximum reverse voltage as a function of junction temperature; typical values

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11. Test information

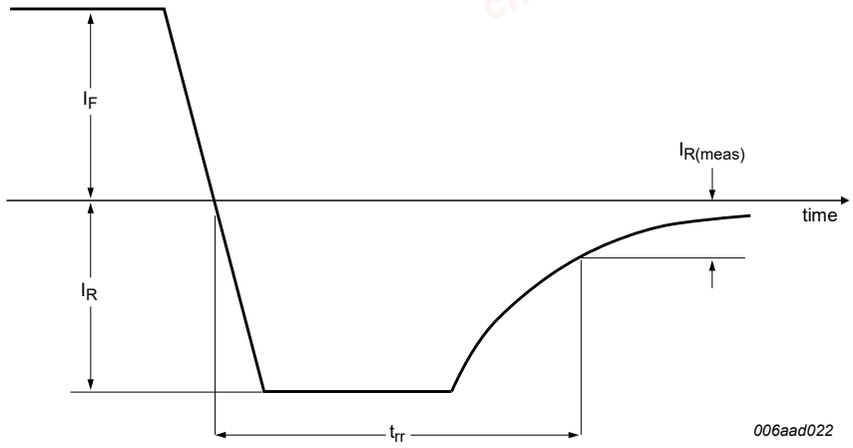


Fig. 14. Reverse recovery definition; step recovery

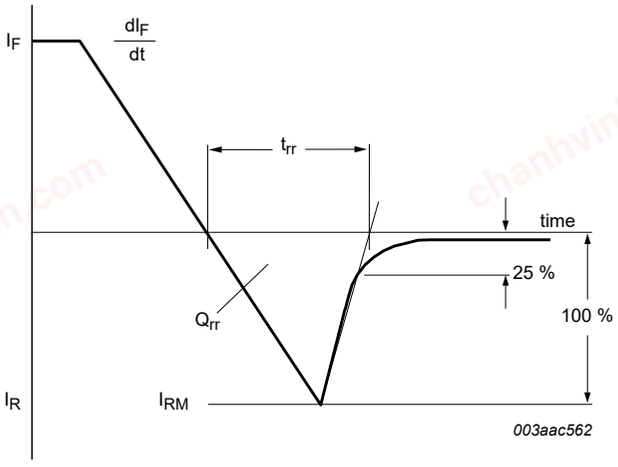


Fig. 15. Reverse recovery definition; ramp recovery

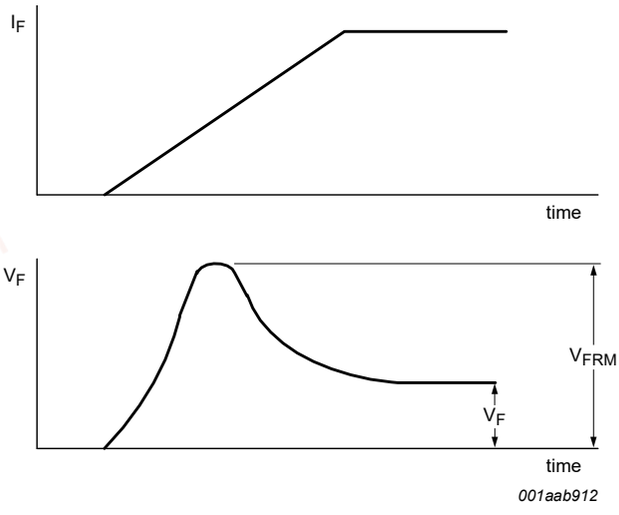


Fig. 16. Forward recovery definition

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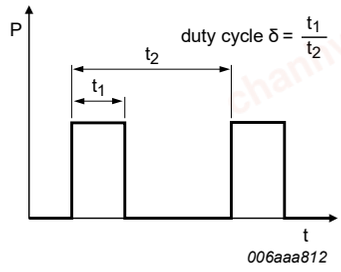


Fig. 17. Duty cycle definition

The current ratings for the typical waveforms are calculated according to the equations:

$I_{F(AV)} = I_M \times \delta$ with I_M defined as peak current

$I_{RMS} = I_{F(AV)}$ at DC, and $I_{RMS} = I_M \times \sqrt{\delta}$

with I_{RMS} defined as RMS current.

12. Package outline

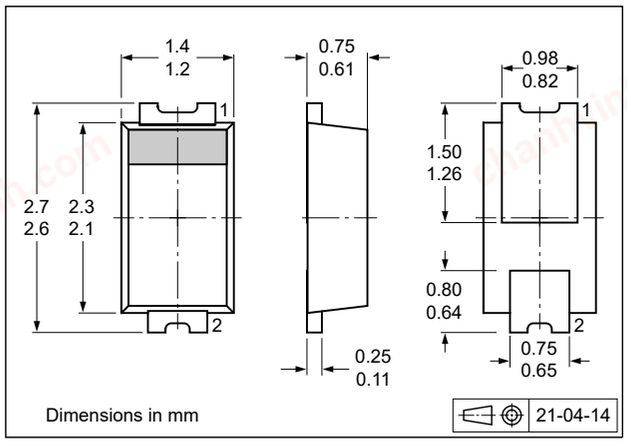


Fig. 18. Package outline CFP2-HP (SOD323HP)

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13. Soldering

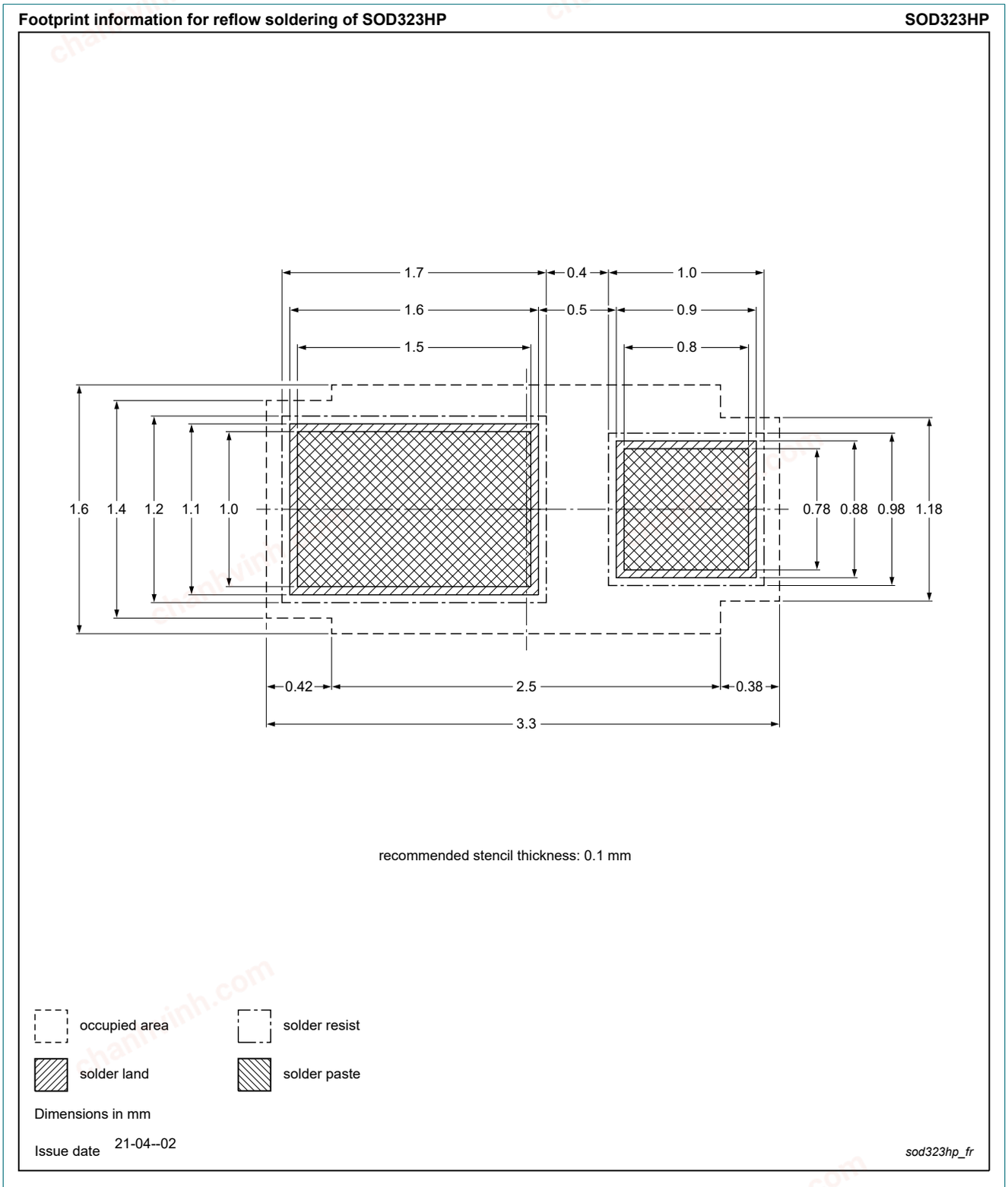


Fig. 19. Reflow soldering footprint for CFP2-HP (SOD323HP)

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14. Revision history

Table 8. Revision history

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
PMEG45T10EXD v.1	20220104	Product data sheet	-	-

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15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.
[2] The term 'short data sheet' is explained in section "Definitions".
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